

HSF

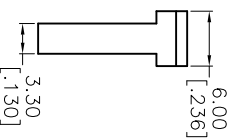
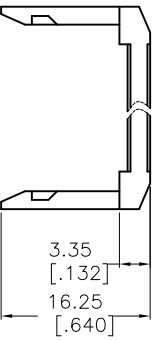
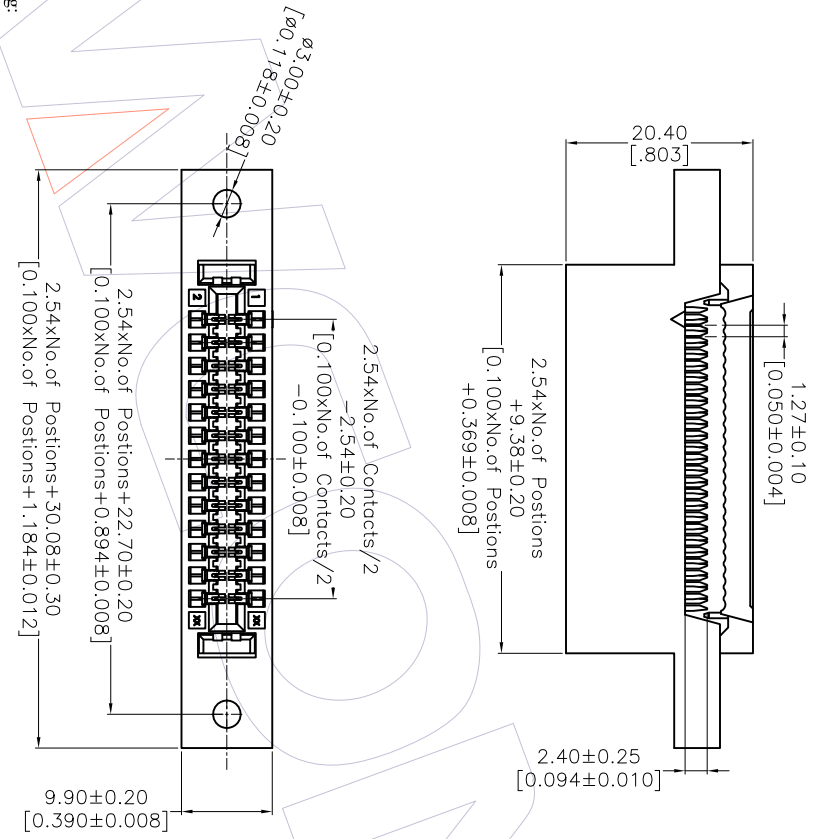
NOTES:

Current Rating: 1.0A AMP
 Contact Resistance: 20milliohm Max
 Withstand Voltage: 500V AC/Minute
 Insulation Resistance: 1000Megohm Min
 Operation Temperature: -40°C to +105°C
 Housing Material: PBT+30%GF(UL94V-0)
 Contact Material: Copper alloy
 Contact plating: Au/Sn over Ni Plating

Ordering Information

5 2 6 0 - X X B P X X B W A 1

No. of Pins: 10-60P
 Type: A=With Clapboard, B=Without Clapboard
 Contact Plating: S0=Gold Flash/Ni, S1=3u"Gold/Ni, S2=5u"Gold/Ni, S3=10u"Gold/Ni, S4=15u"Gold/Ni, S5=30u"Gold/Ni
 Color: B=Black, U=Blue, G=Grey(427C)
 Packing: A=Tray, T=Tube
 SR P/N: G5260-XXCAB01



REV	DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION		DRAW	DATE	SCALE	PART NO.
				X.XX	± 0.40				
A1	2013.07.16	Add SR Parts	YSH	X.XX	± 0.25	CHECK	DATE	mm	TITLE: 2.54mm Card Edge Connector
A0	2011.12.20	NEW	-	X.XXX	± 0.15	APPROVE	DATE	inch	Customer NO.
				Angle	± 3'			SHEET	
				DIM	TOL			PROJ.	

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